

500 nm

Positive Thermal Conductivity Change in PZT Thin Films Under Applied Fields via Substrate Clamping Relief

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Collaborators

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- *Brian Foley*
- *John Gaskins*
- *Patrick Hopkins*

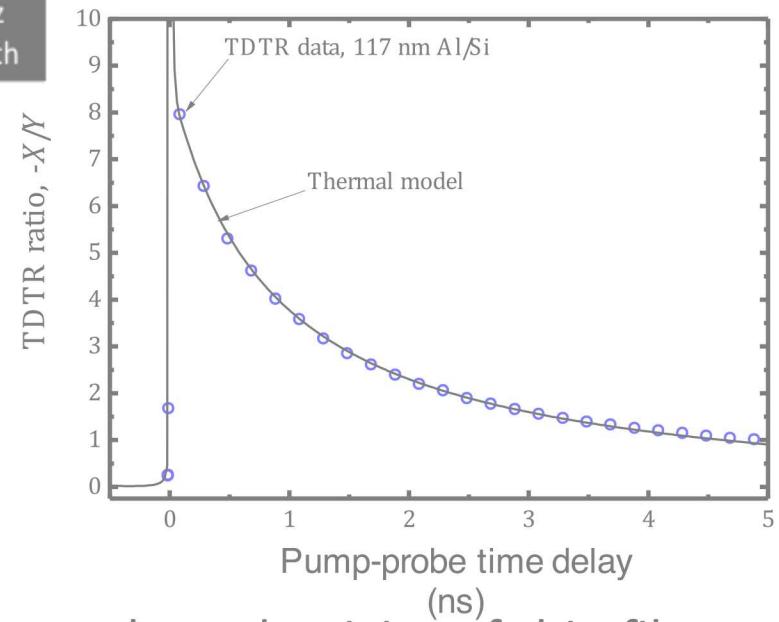
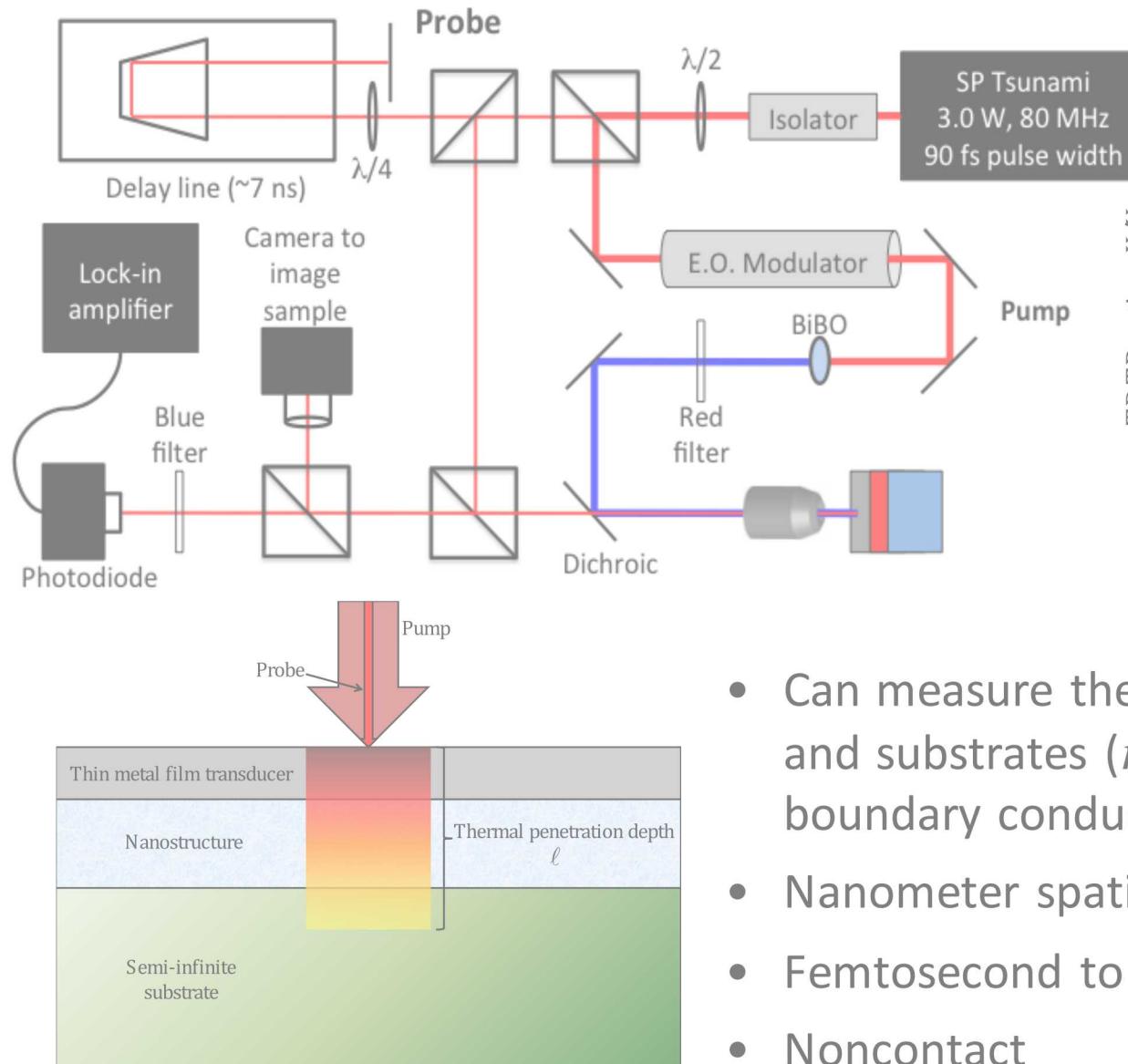
Penn State University

- *Margeaux Wallace*
- *Susan Trolier-McKinstry*

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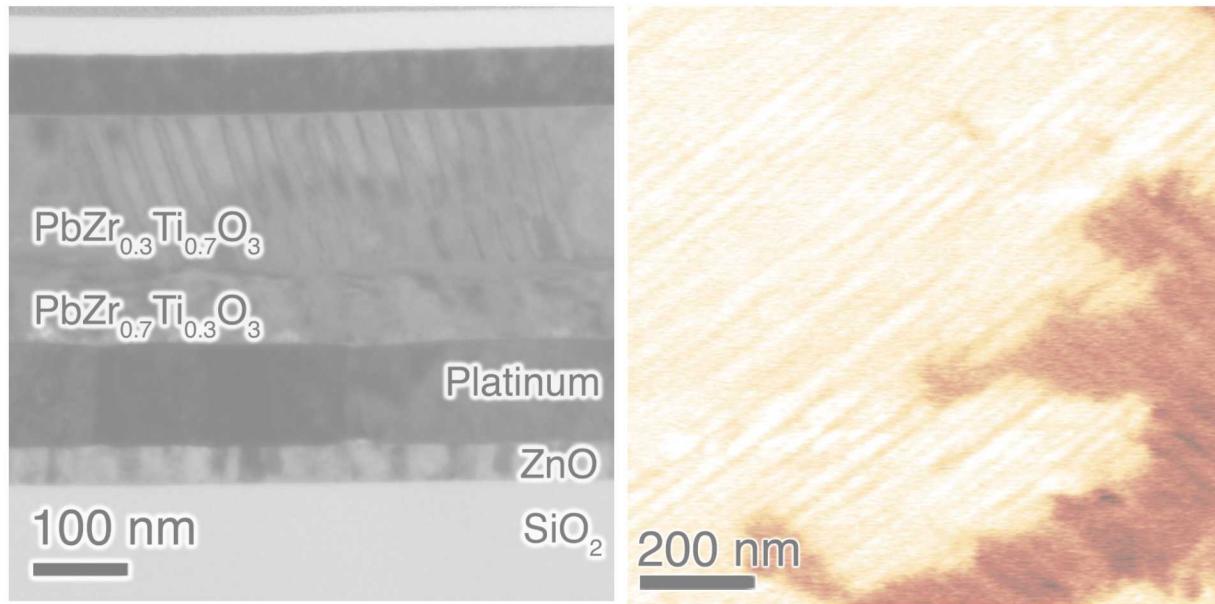
- David Scrymgeour
- Joe Michael
- Bonnie McKenzie
- Douglas Medlin
- Elizabeth Paisley

Time Domain ThermoReflectance (TDTR)

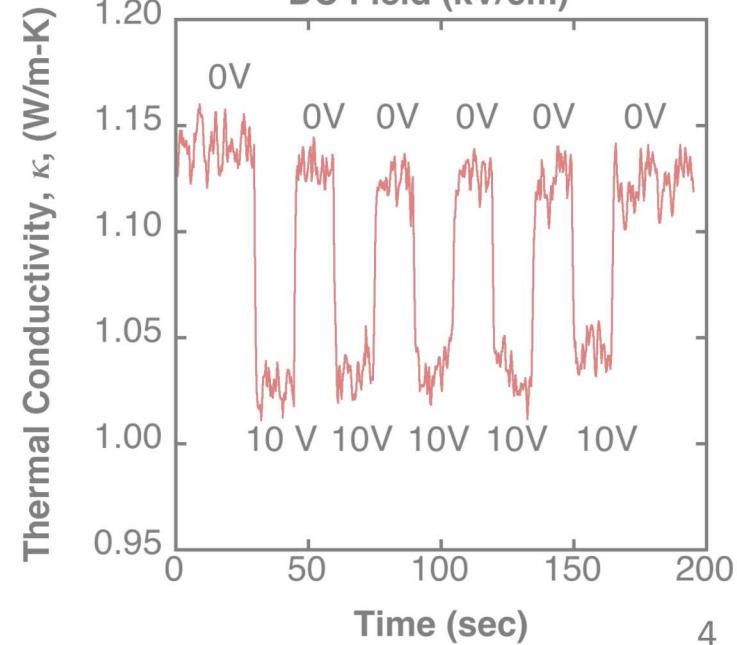
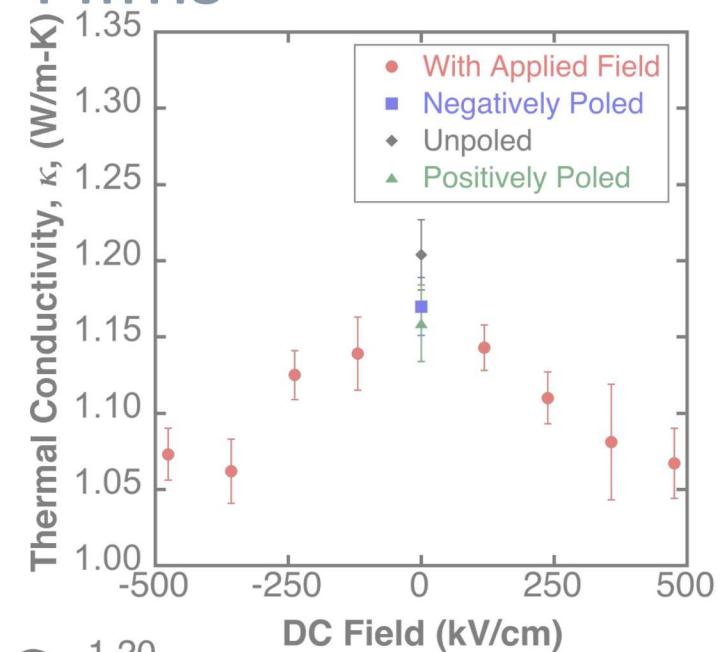


- Can measure thermal conductivity of thin films and substrates (κ) separately from thermal boundary conductance (h_K)
- Nanometer spatial resolution (~ 10 's of nm)
- Femtosecond to nanosecond temporal resolution
- Noncontact

Domain Structure in PZT Bilayer Films



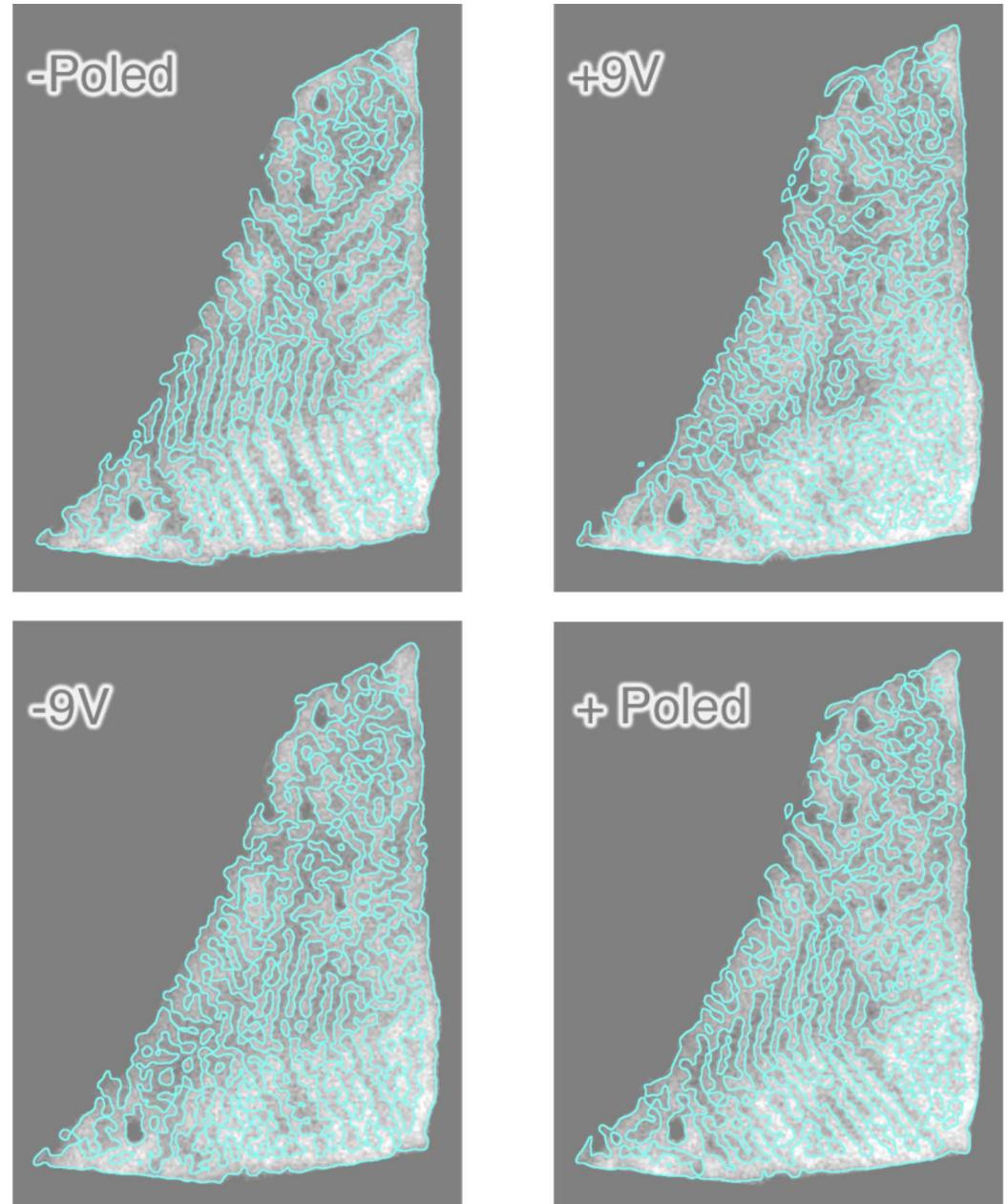
- Bilayer PZT films with high densities of ferroelastic domain walls have been previously shown to allow for voltage regulation of thermal conduction
- ***~12.5% decrease in thermal conductivity with ~500 kV/cm fields***



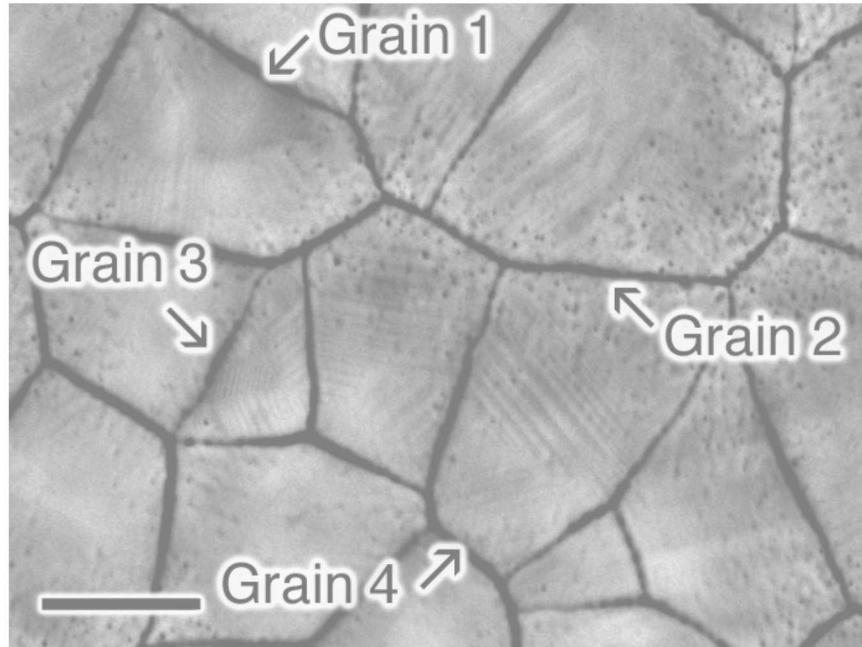
Why does thermal conductivity decrease?



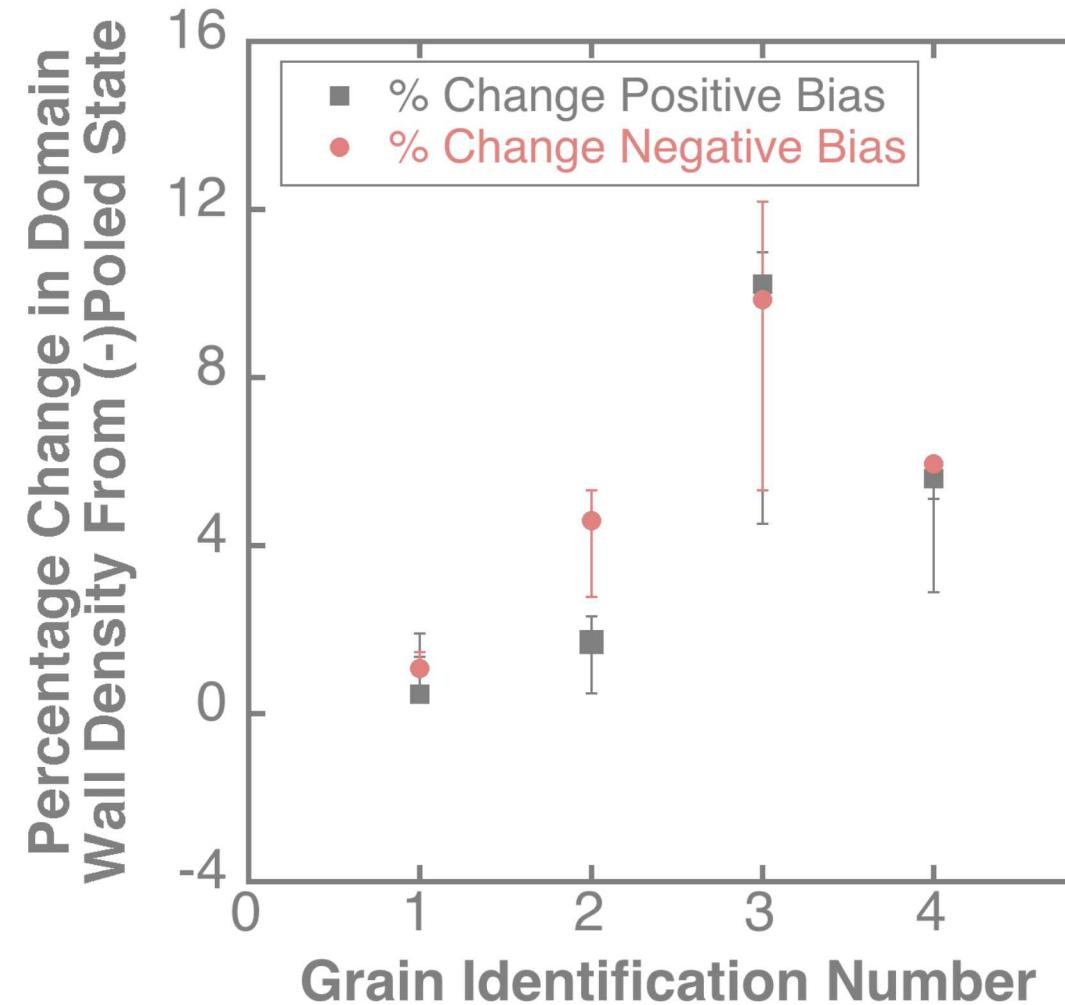
- *In-situ* channeling contrast SEM enables observation of domain structure *during* application of applied voltage
 - 3 nm thick Pt electrode used to allow electron transparency
- Domain structure becomes **more** complex under applied fields



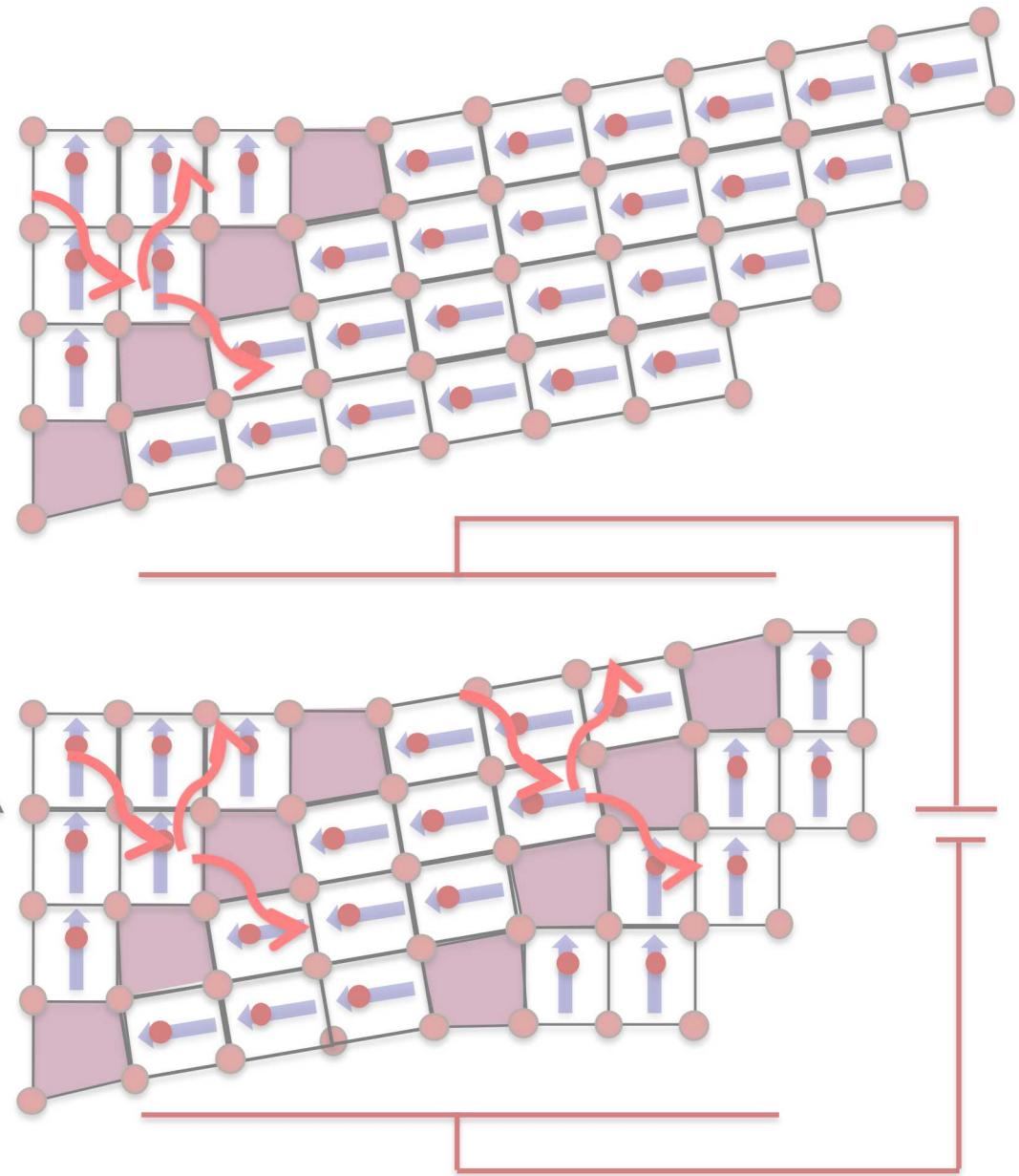
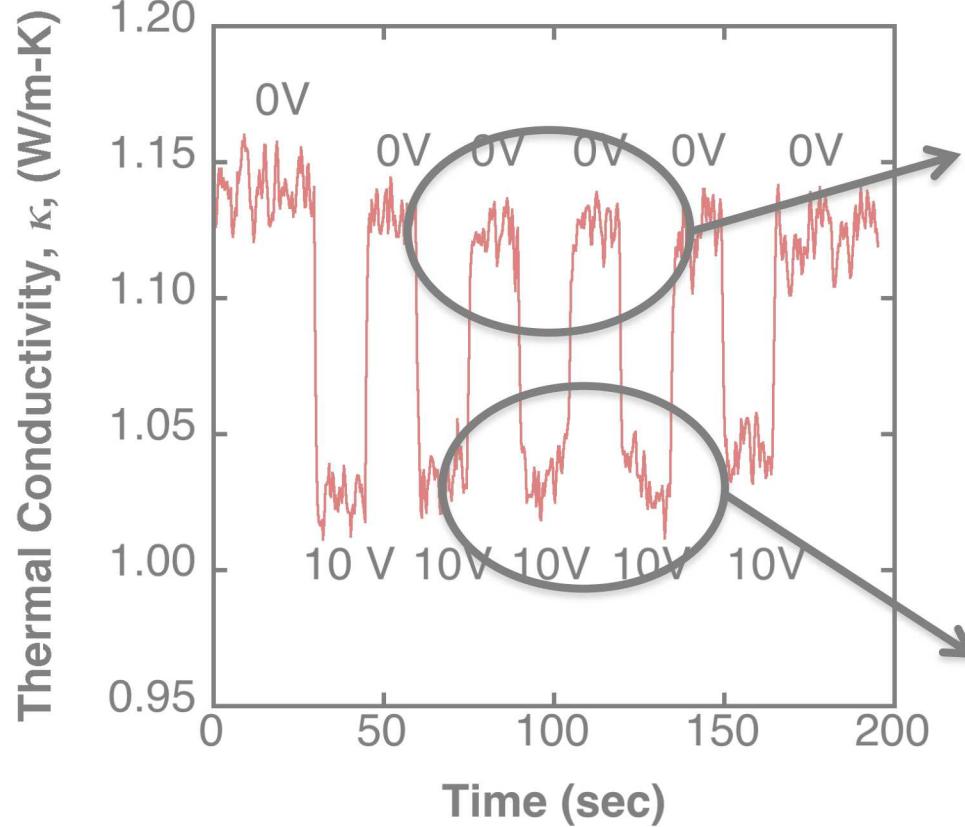
Why does thermal conductivity decrease?



All grains with observable domain structure changes under field show increases in domain density

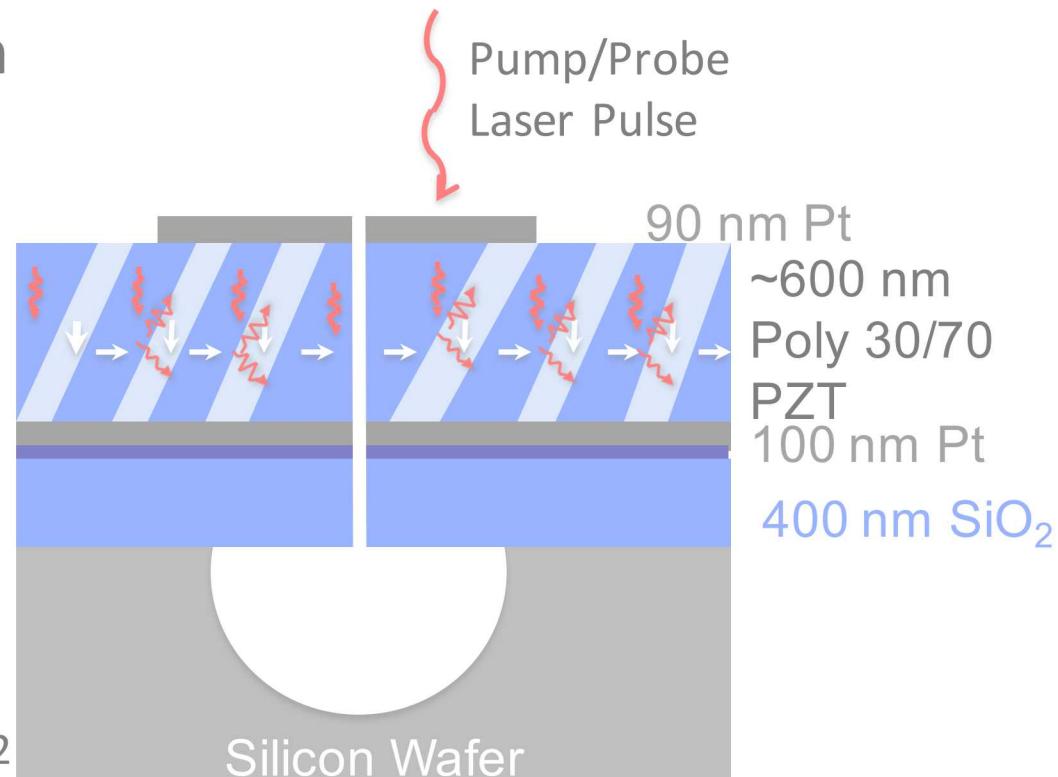


Ferroelastic Domain Walls to Modulate Thermal Conductivity

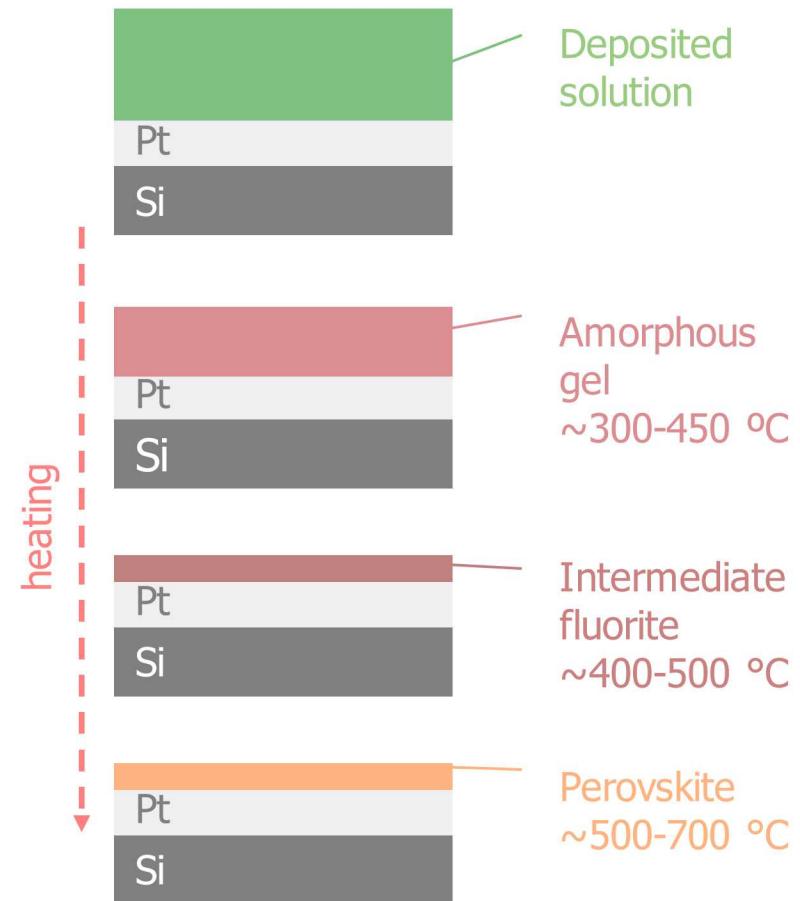
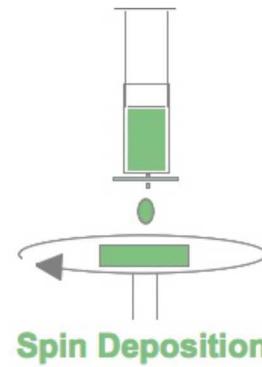
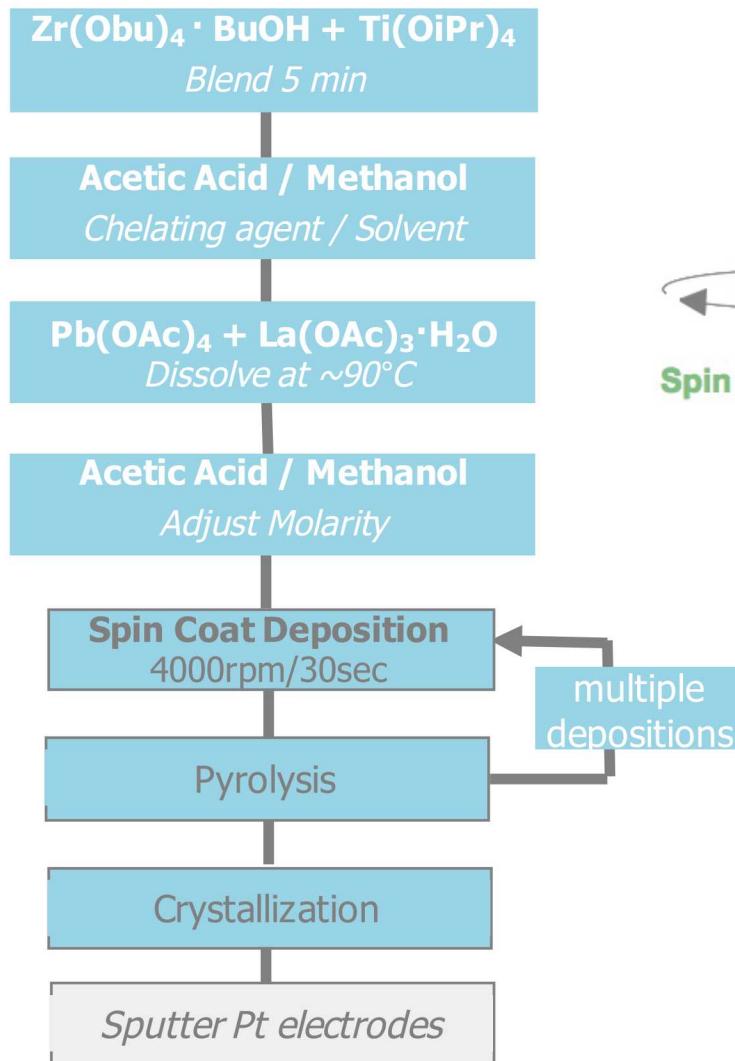


Can We Make Thermal Conductivity Increase?

- Substrate clamping minimizes ferroelastic domain wall motion
- Prevents growth of domains and decrease of domain wall density
- Relieving clamping is expected to increase ferroelastic domain wall mobility*
- Released films prepared by XeF_2 etching into a membrane structure*

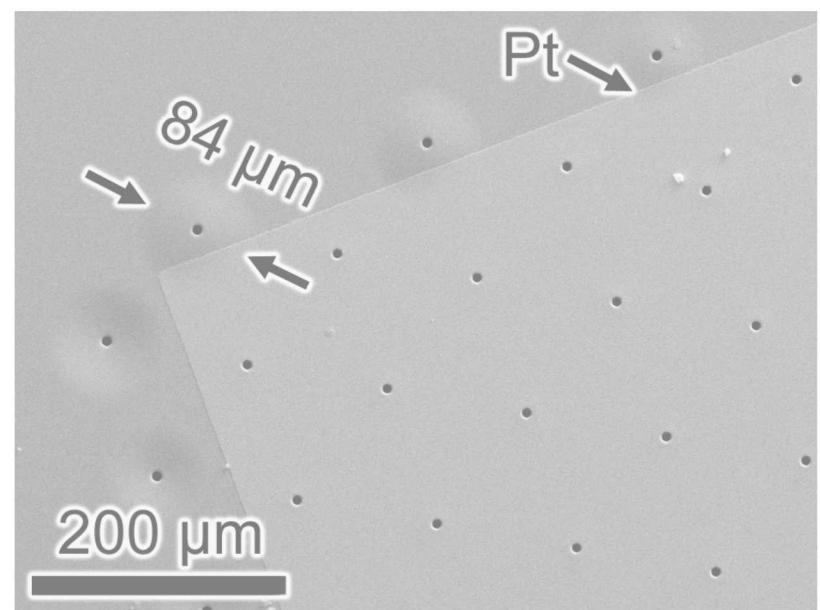
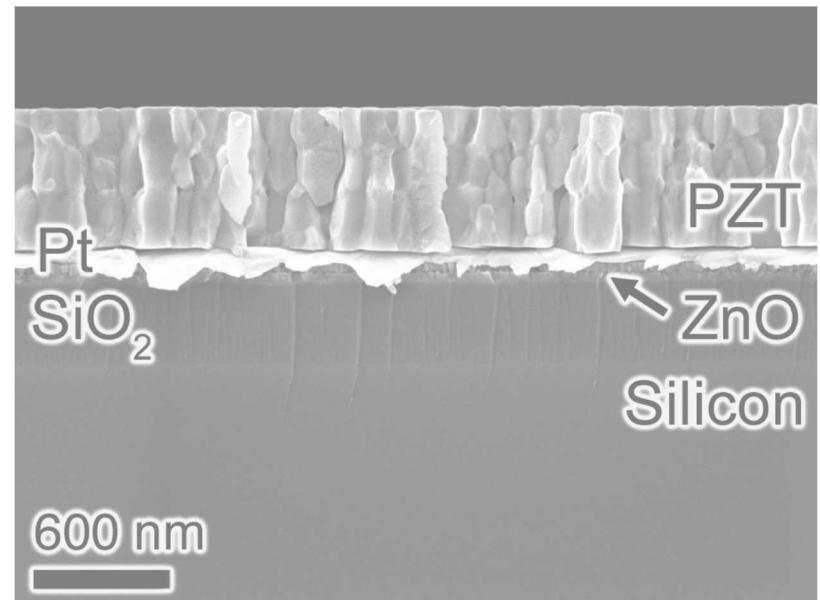
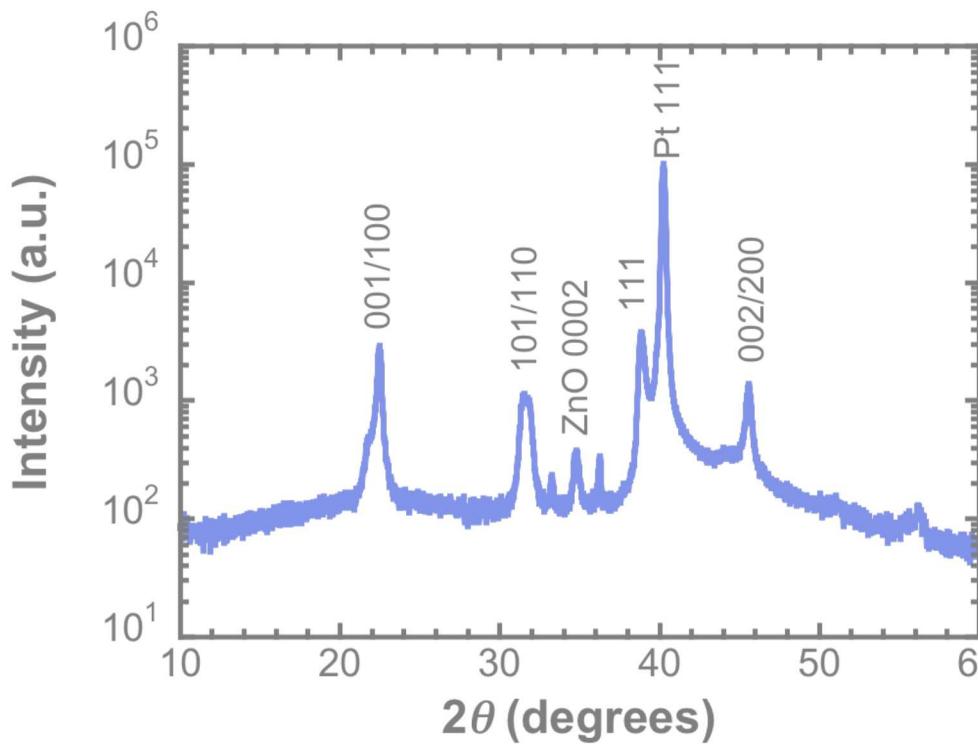


SNL IMO Pb(Zr,Ti)O₃ CSD Film Preparation



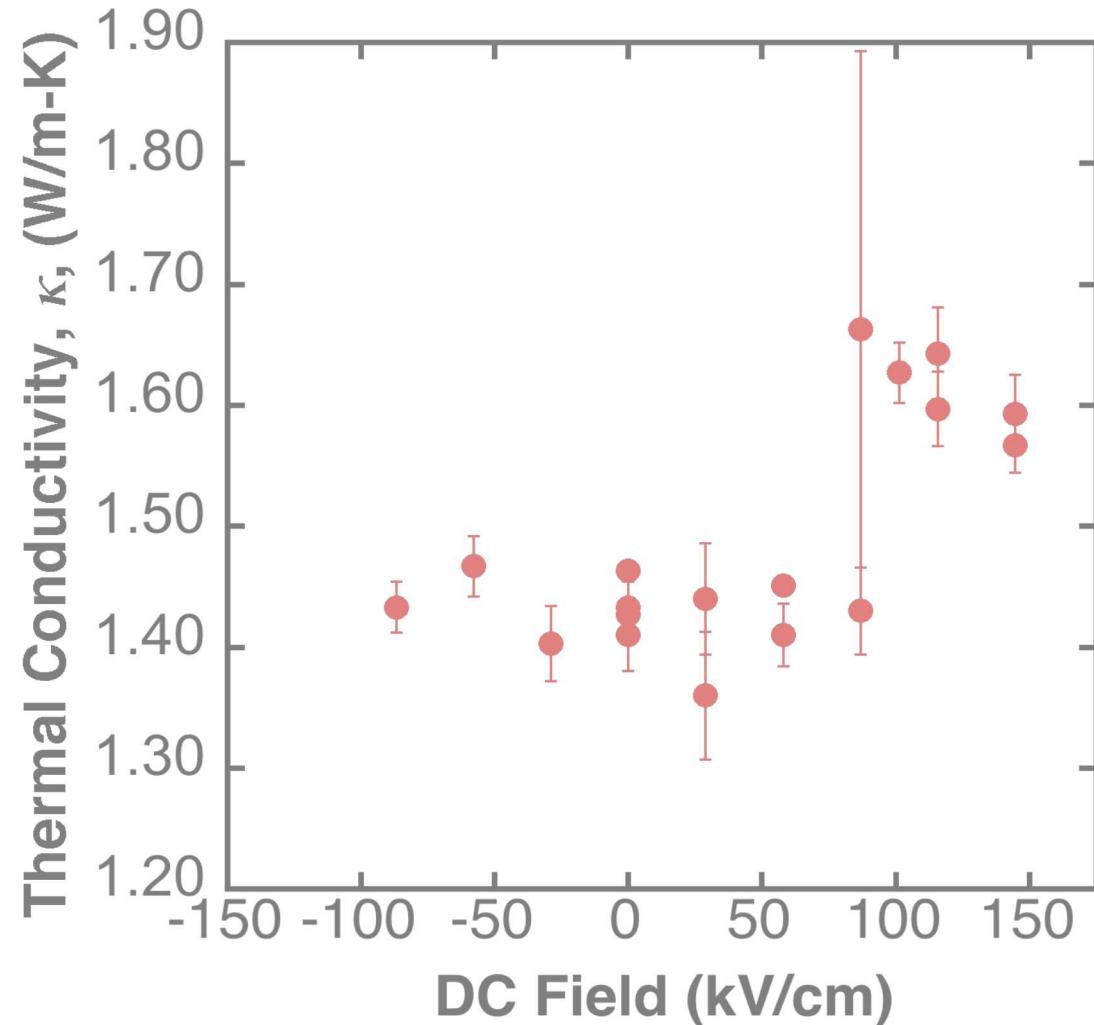
Can We Make Thermal Conductivity Increase?

- PbTiO_3 layer deposited initially to favor 00/ crystallographic texture
- Columnar, dense grain structure
- $\sim 84 \mu\text{m}$ membrane diameter after release



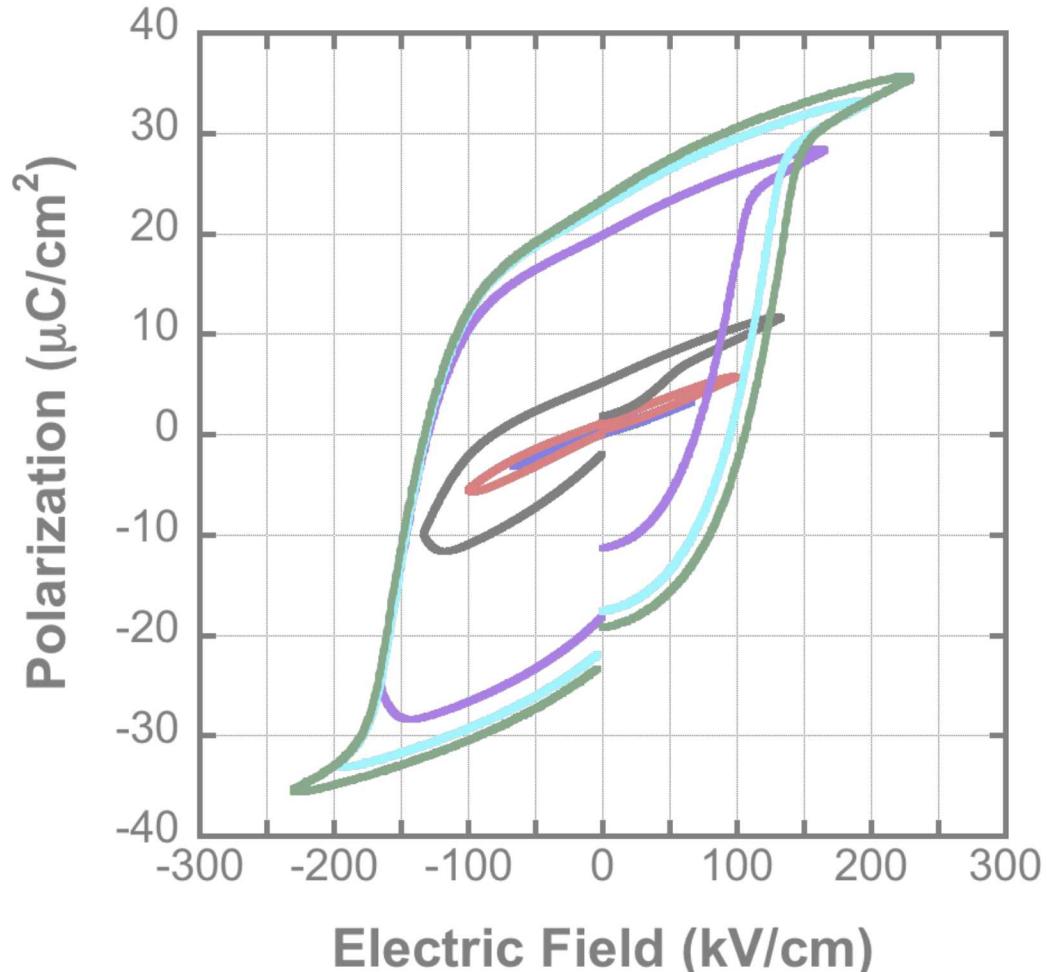
Can We Make Thermal Conductivity Increase?

- Measured thermal conductivity on membrane structure while applying fields
- Observe discontinuous 13% *increase* in κ at ~ 90 kV/cm
- Relieving strain results in increased thermal conduction
 - Is domain wall motion the origin?

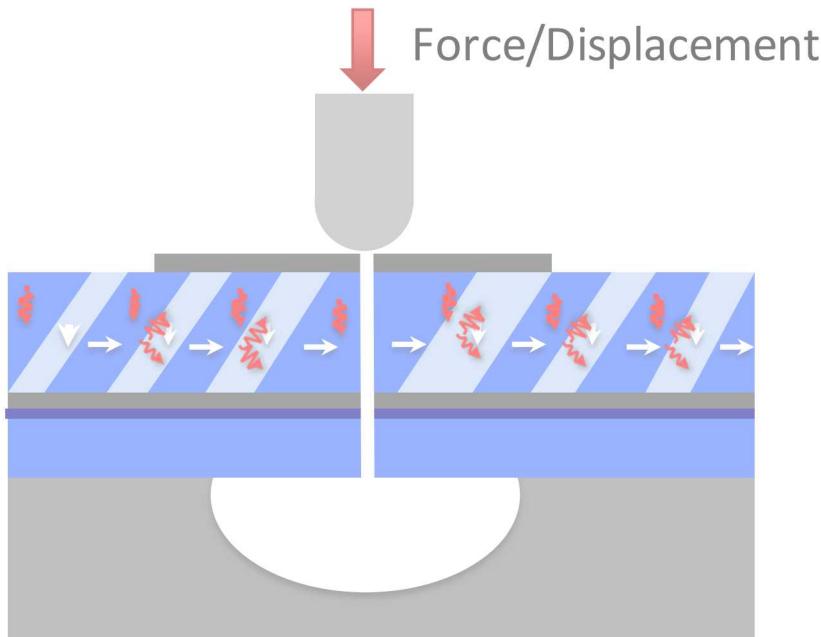


Can We Make Thermal Conductivity Increase?

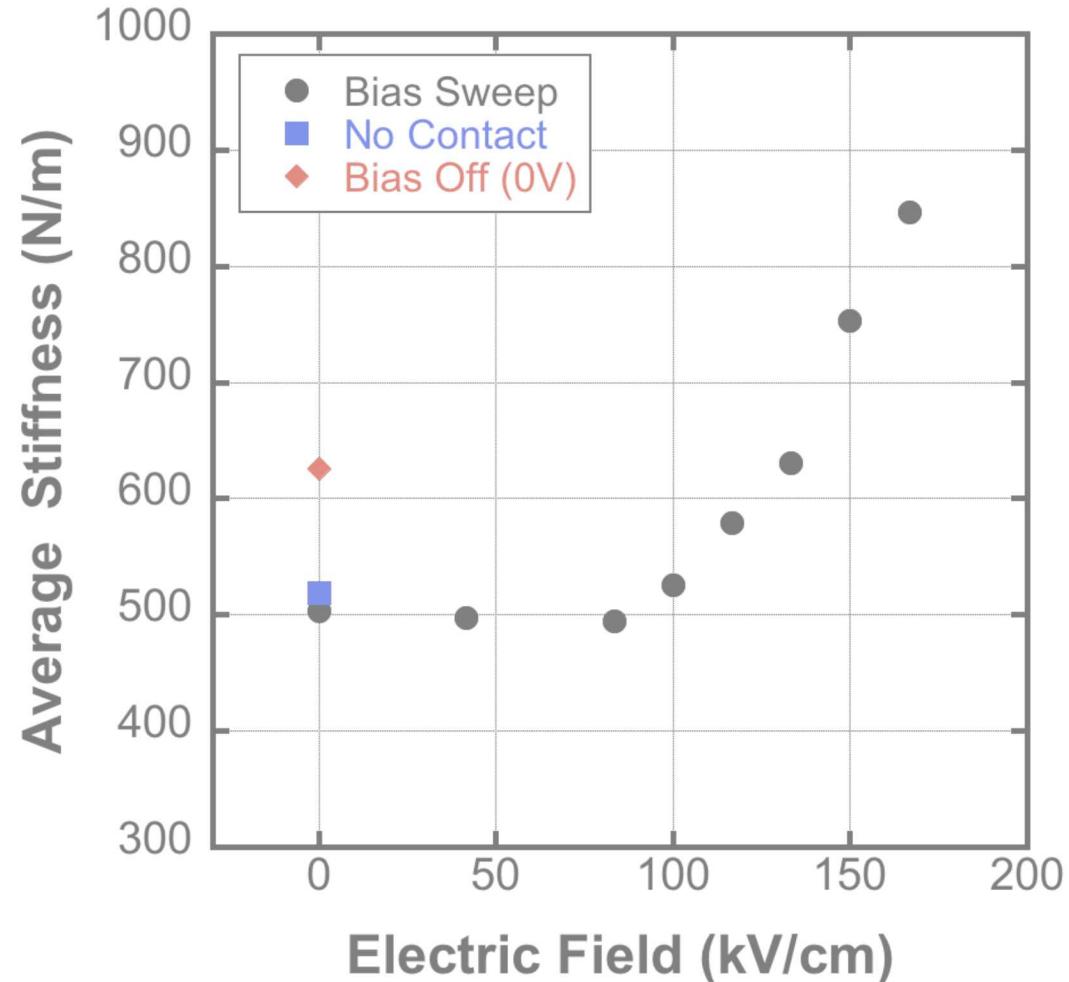
- Polarization-field response measured
 - *Samples both clamped and released regions*
- $E_c = \sim 100\text{-}110 \text{ kV/cm}$
 - E_c from P-E measurements slightly higher than that from the κ -E measurements
 - What is the role of releasing the film?



Can We Make Thermal Conductivity Increase?

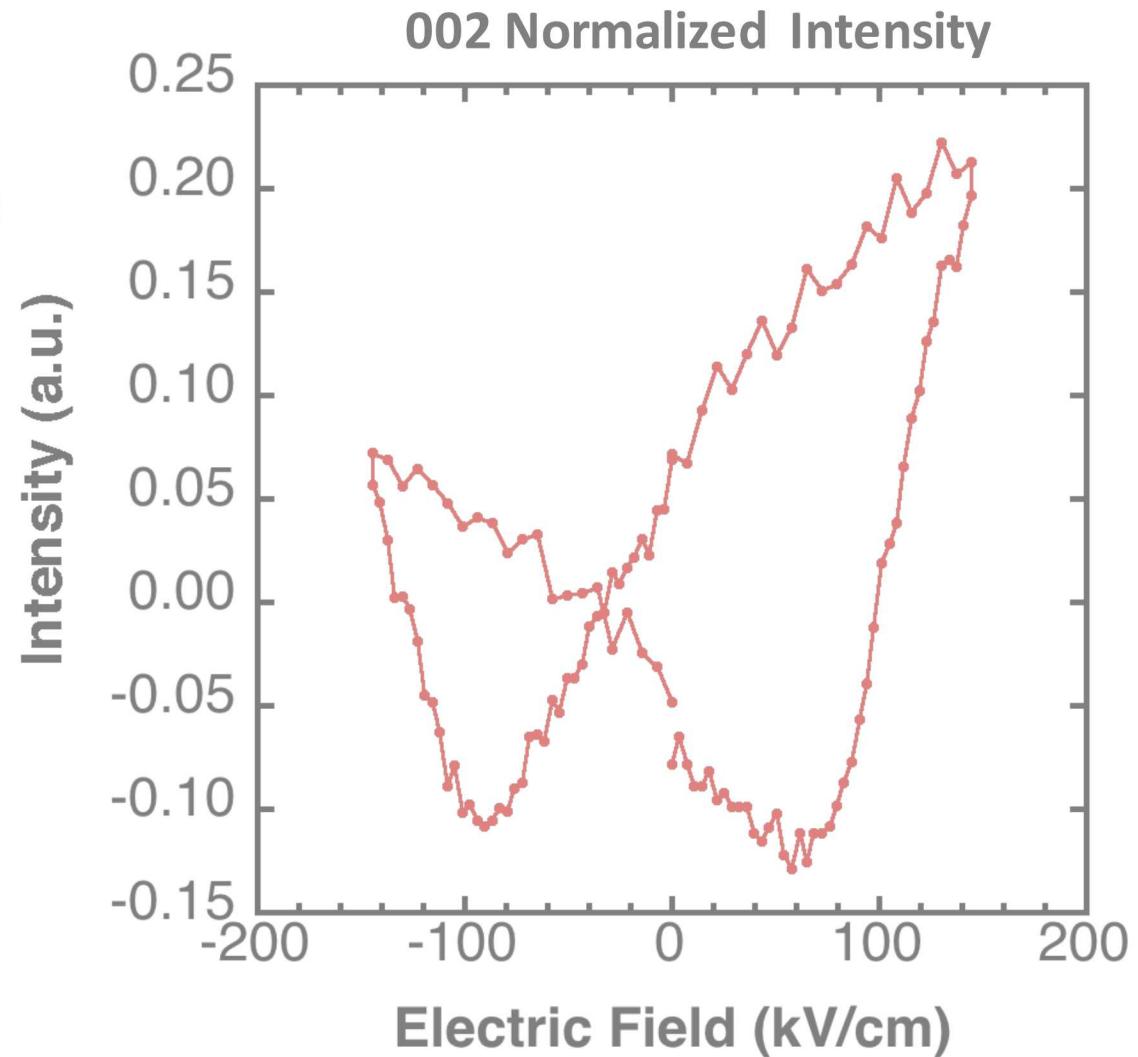


- Nanoindentation stiffness measurements performed on membrane
- Onset of stiffness increase is $\sim 90\text{-}100\text{ kV/cm}$
 - *Correlates with discontinuous κ increase*



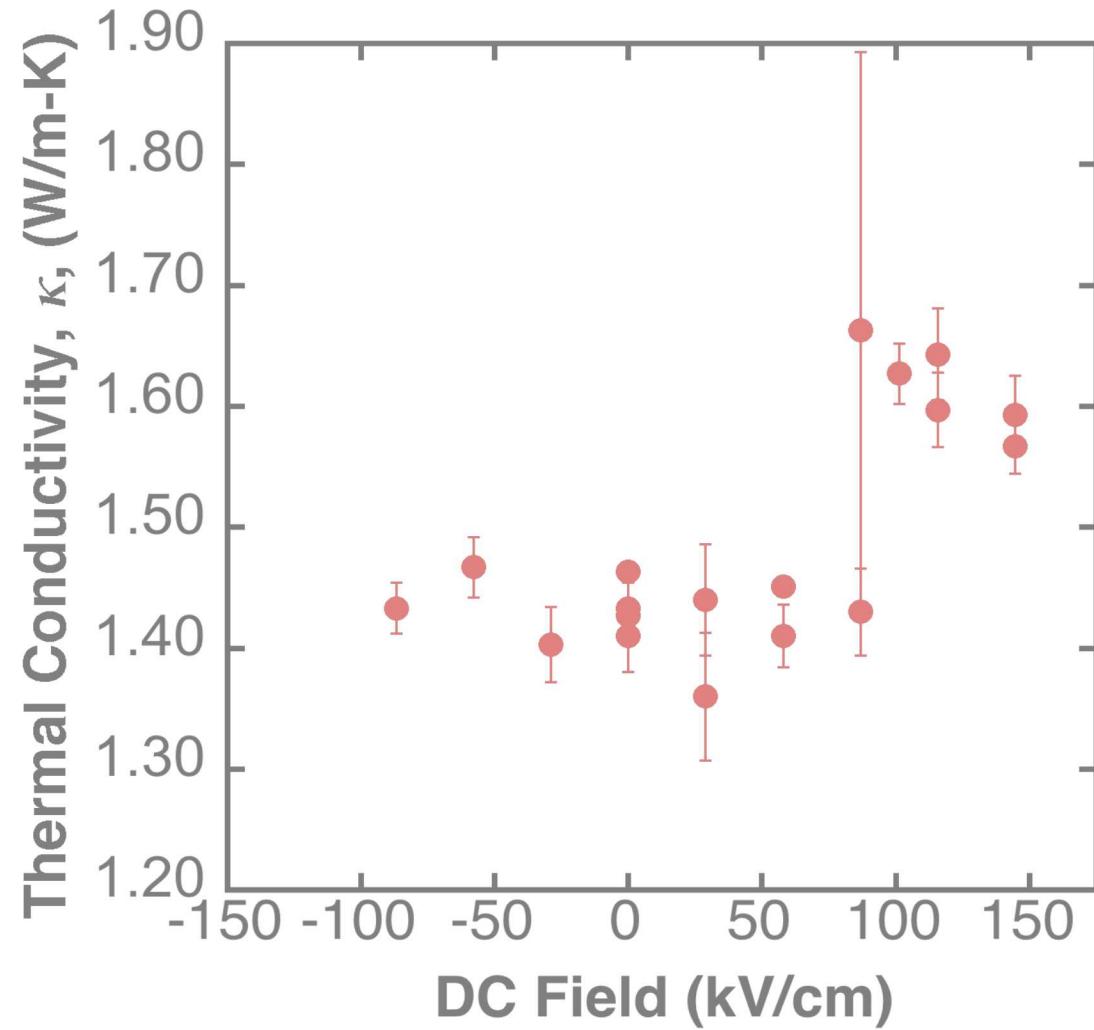
Can We Make Thermal Conductivity Increase?

- X-ray μ -diffraction performed on membrane
- Observe ' d_{33} -like' response
- $E_c = \sim 90$ kV/cm
 - *Correlates with discontinuous κ increase*



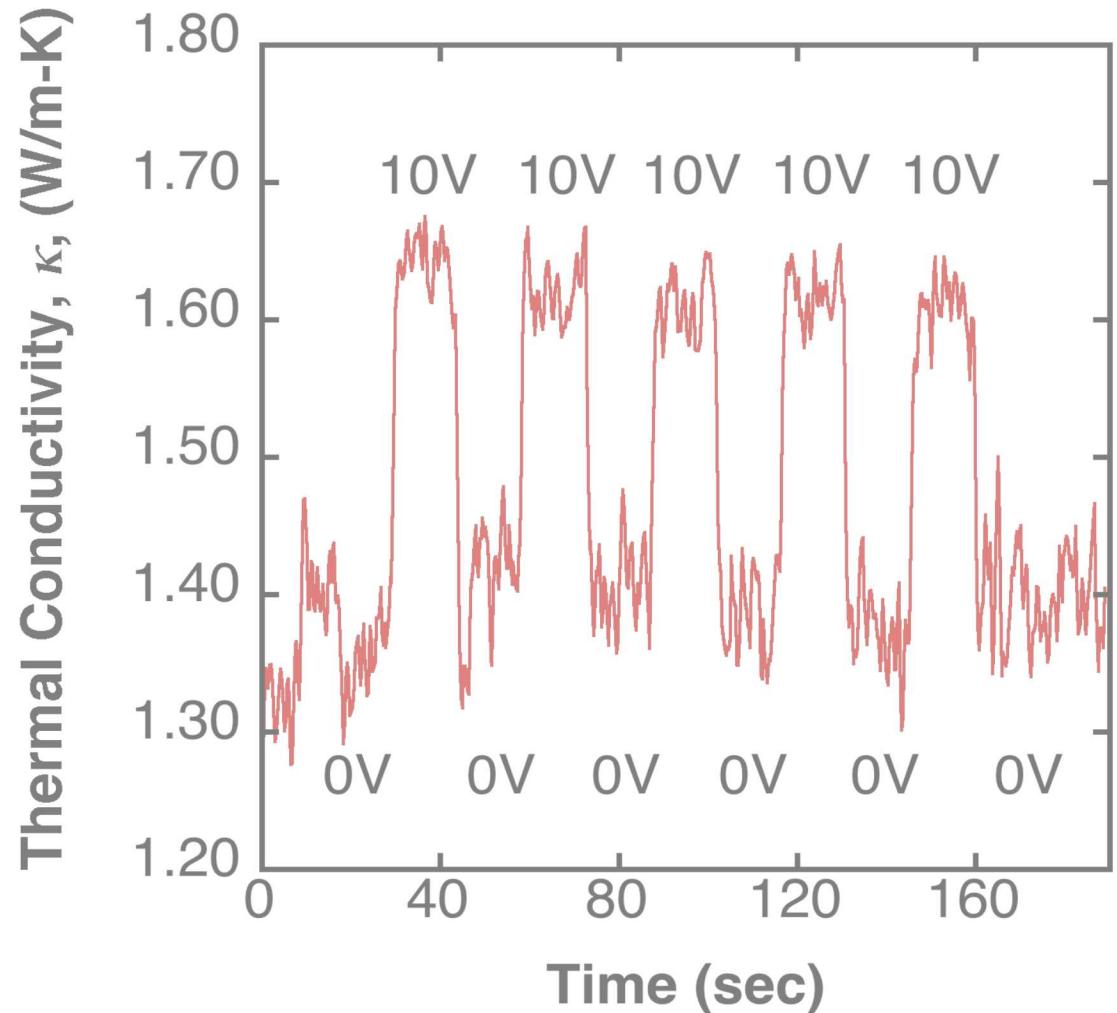
Ferroelastic Domain Wall Motion is Responsible for Thermal Switching Behavior

- Field at which thermal conductivity discontinuity occurs correlates with:
 - Coercive field as measured from $P(E)$ response
 - Onset of stiffness discontinuity in membrane
 - Coercive field as measured from X-ray microdiffraction on membrane
- ***Ferroelastic Domain Wall Reconfiguration is Responsible***



Repeatability of Thermal Switching Behavior

- Temporal response of thermal regulation measured
- Thermal conductivity change for membrane structures is fast
 - Sub-300 ms timescale
- Response is repeatable
 - *Indicates that domain wall densities decrease while under field and increase when field is removed*



Summary

- Both negative and positive voltage coefficients of thermal conductivity can be obtained in ferroelectric thin films
 - Bilayer structures form more domain walls in response to field
 - Strain-relieved structures reduce in domain wall density in response to field
- Ferroelectric films are a promising avenue toward active phonon transport regulation

